10-FZ062TA050SM-P987D13
datasheet

***flow*PFC 0 CD** **650 V / 50 A**

Topology features

- Dual Boost PFC
- Current sense interface in the collector with low inductive bypass diode
- Integrated Shunt Resistor with protection Diode
- Integrated DC capacitor
- Temperature sensor

Component features

- High efficiency in hard switching and resonant topologies
- High speed switching
- Low gate charge

Housing features

- Base isolation: Al_2O_3
- Clip-in, reliable mechanical connection, qualified for wave soldering
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

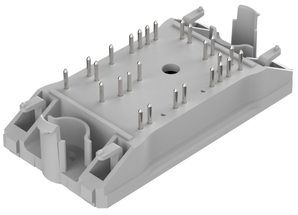
Target applications

- Power Supply
- Welding & Cutting

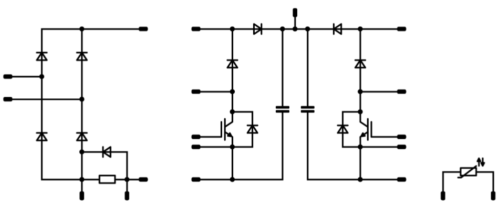
Types

- 10-FZ062TA050SM-P987D13

***flow* 0 12 mm housing**



Schematic



Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit
PFC Switch					
Collector-emitter voltage	V_{CES}			650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$	T_s = 80 °C	43	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}		150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	84	W
Gate-emitter voltage	V_{GES}			±20	V
Maximum junction temperature	T_{jmax}			175	°C
PFC Diode					
Peak repetitive reverse voltage	V_{RRM}			600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	48	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}		60	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, t_p = 10 ms	T_j = 25 °C	310	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	63	W
Maximum junction temperature	T_{jmax}			175	°C
PFC Sw. Protection Diode					
Peak repetitive reverse voltage	V_{RRM}			650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	17	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}		20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	33	W
Maximum junction temperature	T_{jmax}			175	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit
Current Transformer Protection Diode					
Peak repetitive reverse voltage	V_{RRM}			650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	17	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}		20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	33	W
Maximum junction temperature	T_{jmax}			175	°C
Shunt Protection Diode					
Peak repetitive reverse voltage	V_{RRM}			1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	45	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, t_p = 10 ms	T_j = 150 °C	280	A
Surge current capability	I^2t			390	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	59	W
Maximum junction temperature	T_{jmax}			150	°C
Rectifier Diode					
Peak repetitive reverse voltage	V_{RRM}			1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	45	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, t_p = 10 ms	T_j = 150 °C	280	A
Surge current capability	I^2t			390	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	59	W
Maximum junction temperature	T_{jmax}			150	°C
PFC Shunt					
DC current	I			32	A
Power dissipation	P_{tot}		T_c = 70 °C	7	W
Operation Temperature	T_{op}			-55 ... 170	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit
Capacitor (DC)					
Maximum DC voltage	V_{MAX}			1000	V
Operation Temperature	T_{op}			-55 ... 125	°C
Module Properties					
Thermal Properties					
Storage temperature	T_{stg}			-40…+125	°C
Operation temperature under switching condition	T_{jop}			-40…+(T_{jmax} - 25)	°C
Isolation Properties					
Isolation voltage	V_{isol}	DC Test Voltage*	t_p = 2 s	6000	V
Isolation voltage	V_{isol}	AC Voltage	t_p = 1 min	2500	V
Creepage distance				>12,7	mm
Clearance				8,99	mm
Comparative Tracking Index	CTI			≥ 200	

*100 % tested in production

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
PFC Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0005	25	3,3	4	4,7	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 125		1,83 2,01	2,22(1)	V
Collector-emitter cut-off current	I_{CES}		0	650		25			40	µA
Gate-emitter leakage current	I_{GES}		20	0		25			120	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	f = 1 Mhz	0	25		25		3000		pF
Output capacitance	C_{oes}							50		pF
Reverse transfer capacitance	C_{res}							11		pF
Gate charge	Q_g		15	520	50	25		120		nC
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,13		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{gon} = 8 Ω R_{goff} = 8 Ω	0/15	400	50	25 125 150		18,86 18,39 18,5		ns
Rise time	t_r					25 125 150		11,39 12,87 13,01		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		123,04 139,07 143,26		ns
Fall time	t_f					25 125 150		9 7,04 9,07		ns
Turn-on energy (per pulse)	E_{on}	Q_{rFWD}=0,523 µC Q_{rFWD}=1,6 µC Q_{rFWD}=2 µC				25 125 150		0,72 1,04 1,13		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,332 0,48 0,514		mWs

Characteristic Values

Parameter	Symbol	Conditions	V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	Unit
PFC Diode										
Static										
Forward voltage	V_F				30	25 125 150		1,67 1,33 1,24	2,5[(1)]	V
Reverse leakage current	I_R	V_r = 600 V				25			20	µA
Thermal										
Thermal resistance junction to sink [(2)]	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,5		K/W
Dynamic										
Peak recovery current	I_{RM}	d*i*/d*t*=3557 A/µs d*i*/d*t*=2840 A/µs d*i*/d*t*=3262 A/µs	0/15	400	50	25 125 150		34,11 54,83 62,42		A
Reverse recovery time	t_{rr}					25 125 150		30,67 53,6 58,79		ns
Recovered charge	Q_r					25 125 150		0,523 1,6 2		µC
Reverse recovered energy	E_{rec}					25 125 150		0,073 0,294 0,377		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		2927,79 2115,26 2340,37		A/µs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
PFC Sw. Protection Diode										
Static										
Forward voltage	V_F				10	25 125	1,23	1,67 1,56	1,87(1)	V
Reverse leakage current	I_R	V_r = 650 V				25			0,14	µA
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						2,87		K/W
Current Transformer Protection Diode										
Static										
Forward voltage	V_F				10	25 125	1,23	1,67 1,56	1,87(1)	V
Reverse leakage current	I_R	V_r = 650 V				25			0,14	µA
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						2,87		K/W
Shunt Protection Diode										
Static										
Forward voltage	V_F				50	25 125		1,32 1,33	1,3(1) 1,33(1)	V
Reverse leakage current	I_R	V_r = 1600 V				25 150			20 1500	µA
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,2		K/W

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Rectifier Diode										
Static										
Forward voltage	V_F				50	25 125		1,32 1,33	1,3[1] 1,33[1]	V
Reverse leakage current	I_R	V_r = 1600 V				25 150			20 1500	µA
Thermal										
Thermal resistance junction to sink [2]	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,2		K/W
PFC Shunt										
Static										
Resistance	R							6,8		mΩ
Tolerance							-1		1	%
Temperature coeficient	tc								100	ppm/K
Capacitor (DC)										
Static										
Capacitance	C	DC bias voltage = 0 V				25		100		nF
Tolerance							10		10	%
Dissipation factor		f = 1 kHz				25		2,5		%

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_{F} [V]	I_{C} [A] I_{D} [A] I_{F} [A]	T_{j} [°C]	Min	Typ	Max	
Thermistor										
Static										
Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	R_{100} = 1484 Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

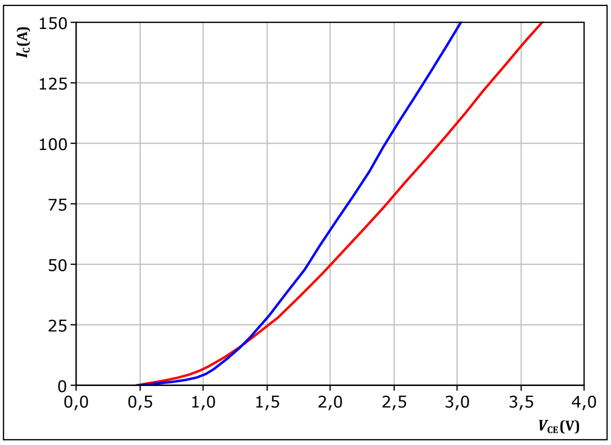
(1) Value at chip level
(2) Only valid with pre-applied Vincotech thermal interface material.

PFC Switch Characteristics

figure 1. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



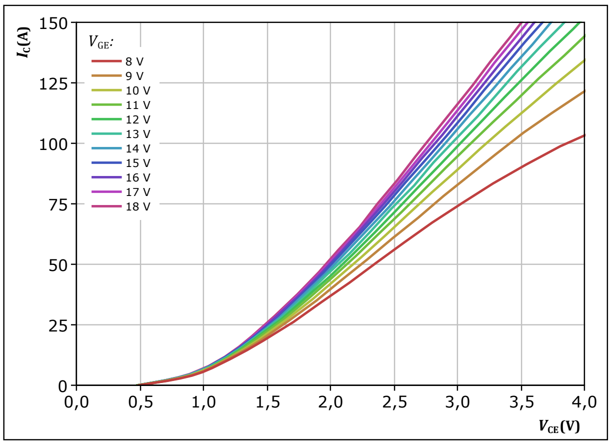
t_p =	250	μs
V_{GE} =	15	V

T_j: 25 °C, 125 °C

figure 2. IGBT

Typical output characteristics

$I_C = f(V_{CE})$



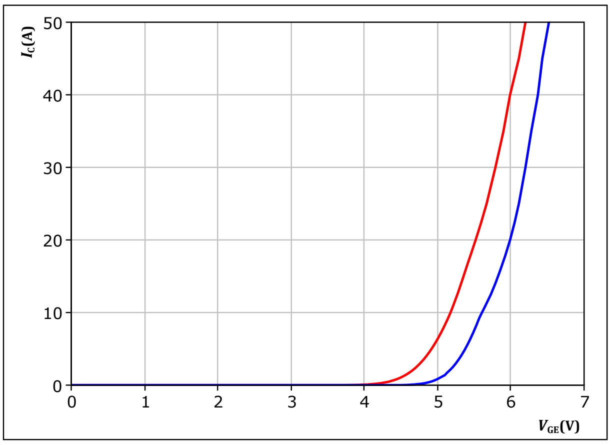
t_p =	250	μs
T_j =	125	°C

V_{GE} from 8 V to 18 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$



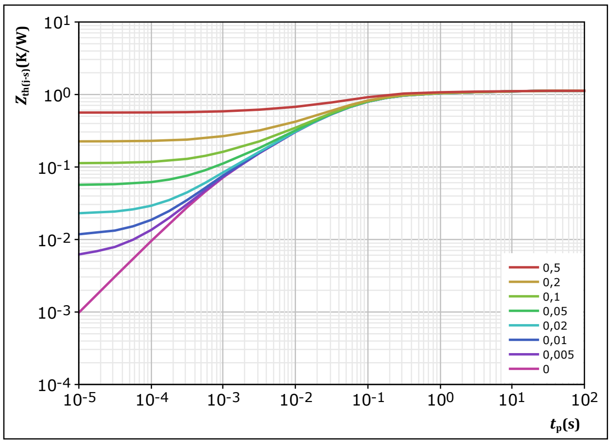
t_p =	250	μs
V_{CE} =	10	V

T_j: 25 °C, 125 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D =	t_p / T	
$R_{th(j-s)}$ =	1,126	K/W

IGBT thermal model values

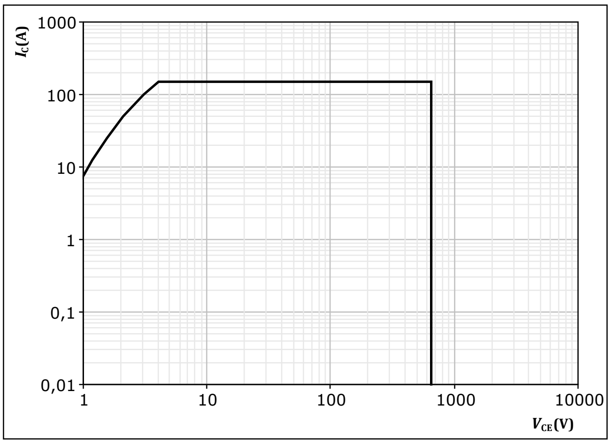
R (K/W)	τ (s)
7,12E-02	8,15E+00
1,29E-01	6,00E-01
4,31E-01	9,13E-02
3,15E-01	2,59E-02
1,31E-01	5,80E-03
5,02E-02	8,53E-04

PFC Switch Characteristics

figure 5.	IGBT

Safe operating area

I_C = f(V_{CE})

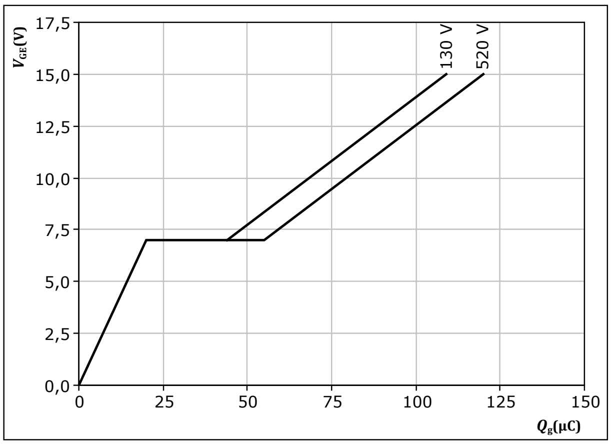


D =	single pulse	
T_s =	80	°C
V_{GE} =	15	V
T_j =	T_{jmax}	

figure 6.	IGBT

Gate voltage vs gate charge

V_{GE} = f(Q_g)



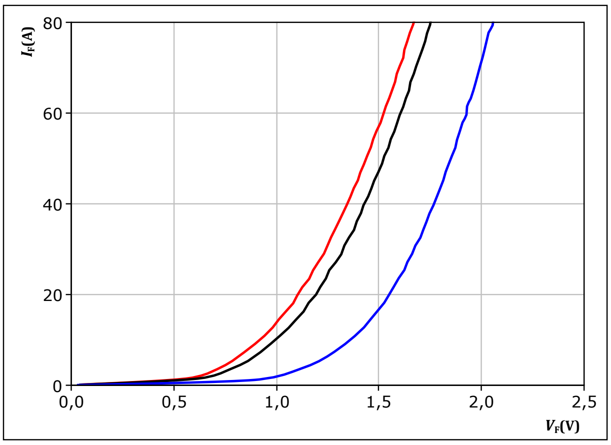
I_C =	50	A
T_j =	25	°C

PFC Diode Characteristics

figure 7. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



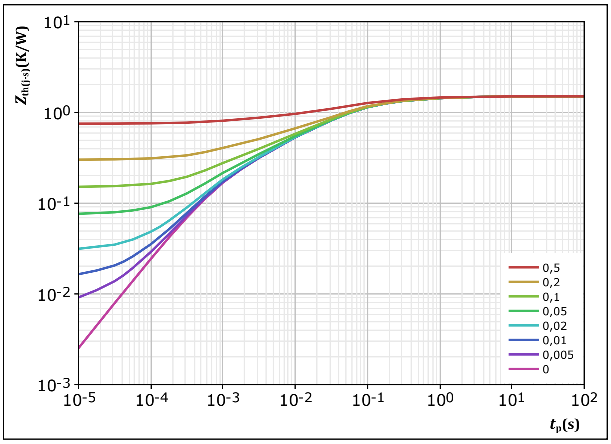
t_p = 250 µs

T_j: 25 °C, 125 °C, 150 °C

figure 8. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 1,505 K/W

FWD thermal model values

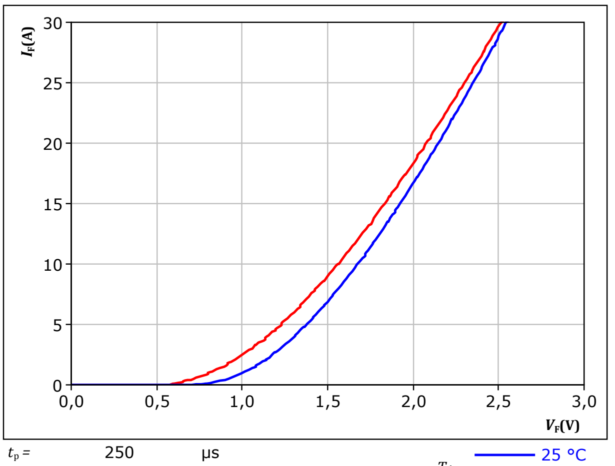
R (K/W)	τ (s)
1,05E-01	2,13E+00
3,09E-01	2,20E-01
6,31E-01	4,50E-02
3,01E-01	6,71E-03
1,59E-01	8,19E-04

PFC Sw. Protection Diode Characteristics

figure 9. **FWD**

Typical forward characteristics

I_F = f(V_F)



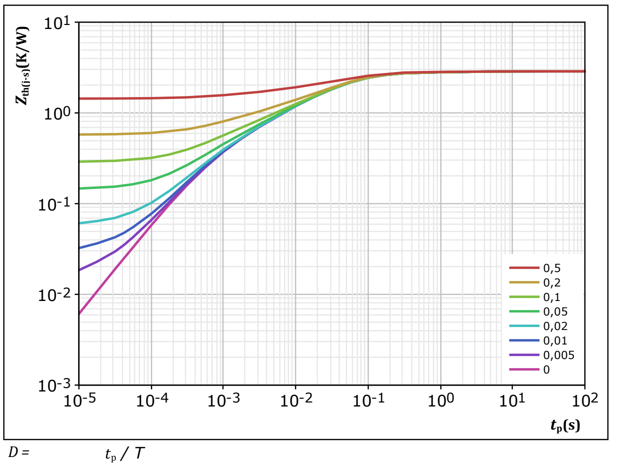
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 10. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)}$ = f(t_p)



D = t_p / T

$R_{th(j-s)}$ = 2,873 K/W

FWD thermal model values

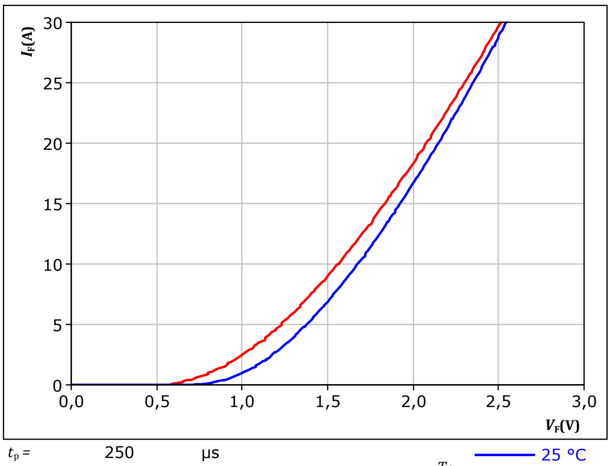
R (K/W)	τ (s)
6,53E-02	3,94E+00
1,48E-01	4,48E-01
1,31E+00	5,96E-02
7,32E-01	1,36E-02
4,04E-01	2,79E-03
2,11E-01	5,37E-04

Current Transformer Protection Diode Characteristics

figure 11. FWD

Typical forward characteristics

$I_F = f(V_F)$



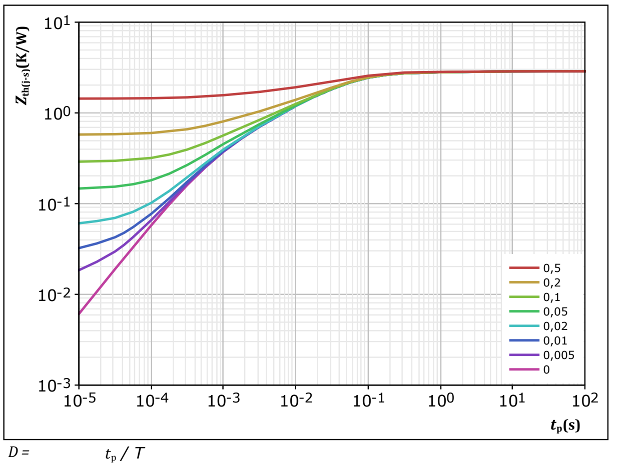
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 12. FWD

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 2,873 K/W

FWD thermal model values

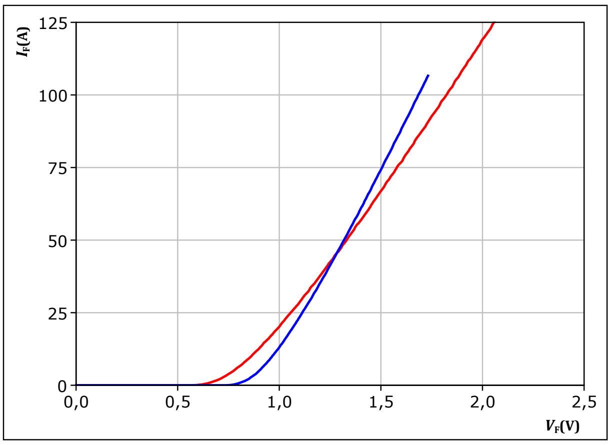
R (K/W)	τ (s)
6,53E-02	3,94E+00
1,48E-01	4,48E-01
1,31E+00	5,96E-02
7,32E-01	1,36E-02
4,04E-01	2,79E-03
2,11E-01	5,37E-04

Shunt Protection Diode Characteristics

figure 13. **Rectifier**

Typical forward characteristics

I_F = f(V_F)



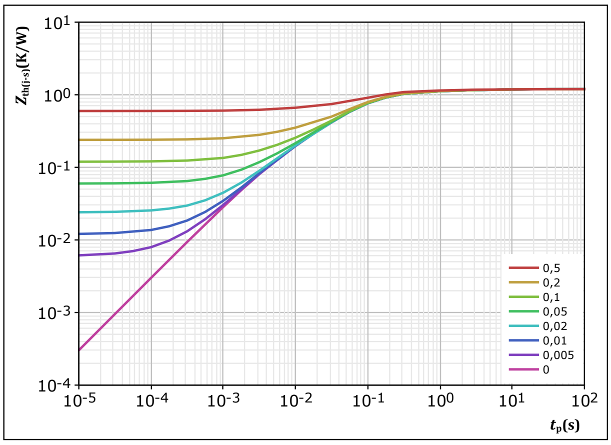
t_p = 250 μs

T_j: 25 °C, 125 °C

figure 14. **Rectifier**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)}$ = f(t_p)



D = t_p / T

$R_{th(j-s)}$ = 1,195 K/W

Rectifier thermal model values

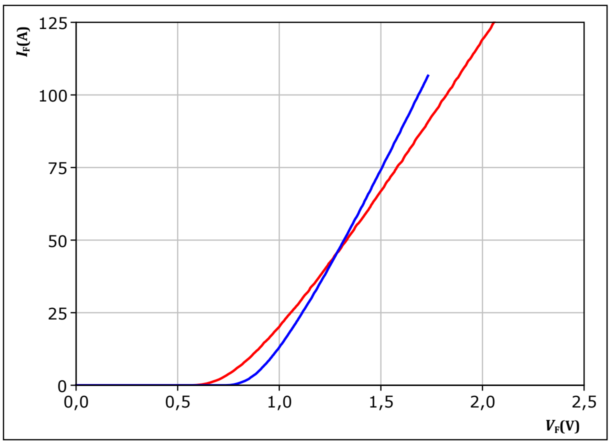
R (K/W)	τ (s)
4,87E-02	6,80E+00
1,57E-01	6,29E-01
7,33E-01	9,05E-02
1,69E-01	3,10E-02
7,37E-02	4,76E-03
1,39E-02	1,53E-02

Rectifier Diode Characteristics

figure 15. **Rectifier**

Typical forward characteristics

$I_F = f(V_F)$



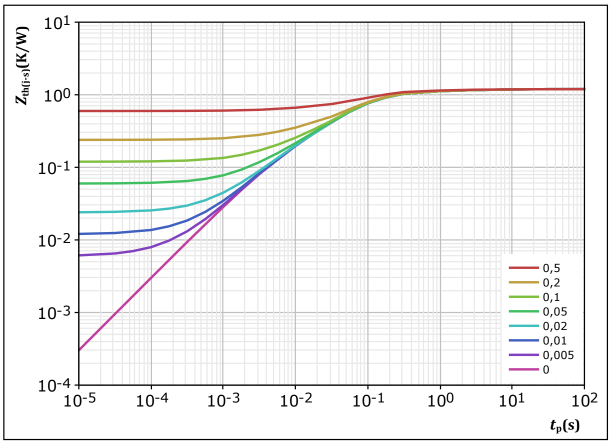
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 16. **Rectifier**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 1,195 K/W

Rectifier thermal model values

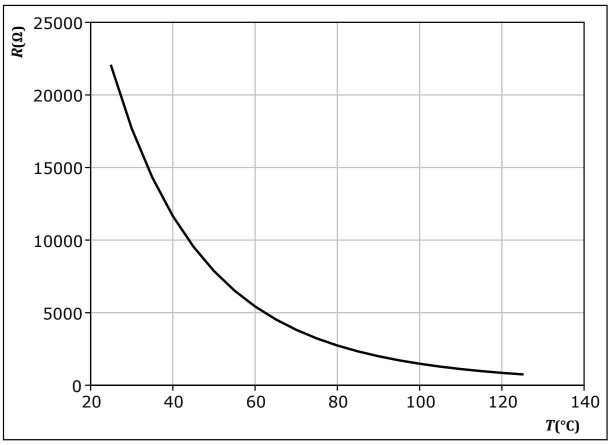
R (K/W)	τ (s)
4,87E-02	6,80E+00
1,57E-01	6,29E-01
7,33E-01	9,05E-02
1,69E-01	3,10E-02
7,37E-02	4,76E-03
1,39E-02	1,53E-02

Thermistor Characteristics

figure 17.	Thermistor

Typical NTC characteristic as function of temperature

$R_T = f(T)$

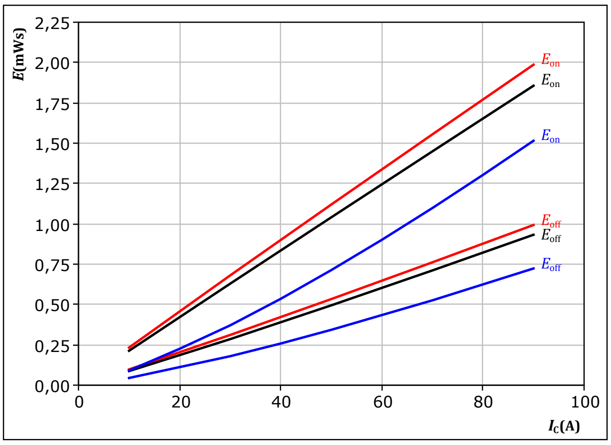


PFC Switching Characteristics

figure 18. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



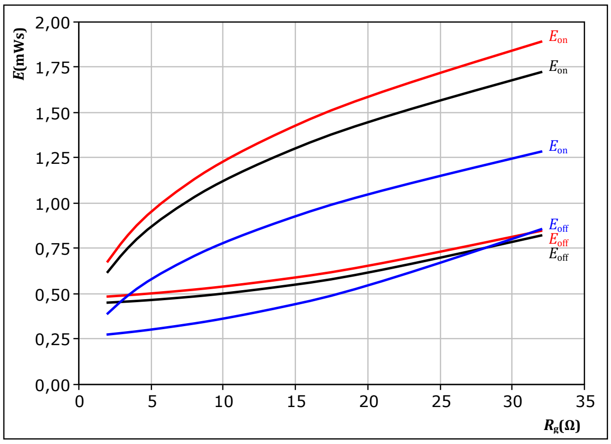
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	8	Ω		150 °C
R_{goff} =	8	Ω		

figure 19. **IGBT**

Typical switching energy losses as a function of IGBT turn on gate resistor

$E = f(R_g)$



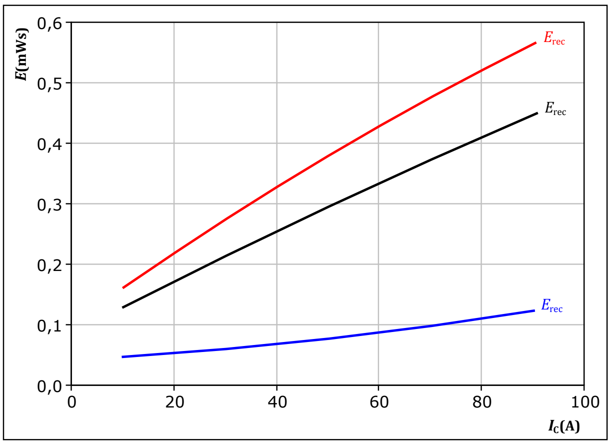
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	50	A		150 °C

figure 20. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



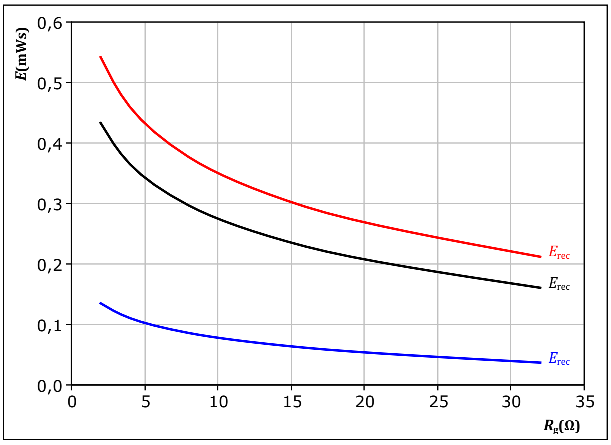
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	8	Ω		150 °C

figure 21. **FWD**

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

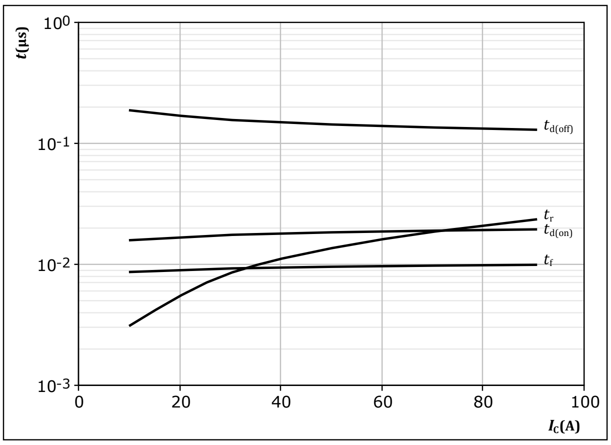
V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	50	A		150 °C

PFC Switching Characteristics

figure 22. **IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



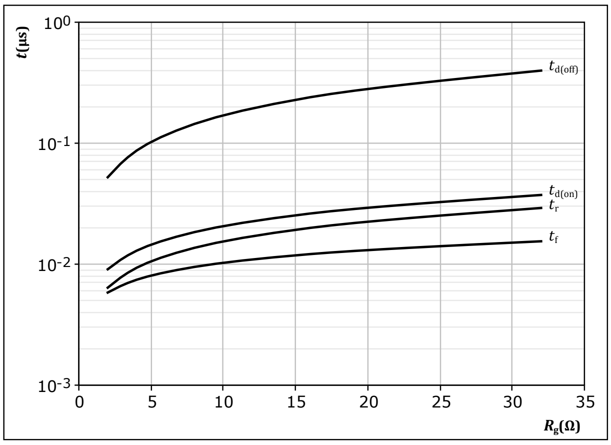
With an inductive load at

T_j =	150	°C
V_{CE} =	400	V
V_{GE} =	0/15	V
R_{gon} =	8	Ω
R_{goff} =	8	Ω

figure 23. **IGBT**

Typical switching times as a function of IGBT turn on gate resistor

$t = f(R_g)$



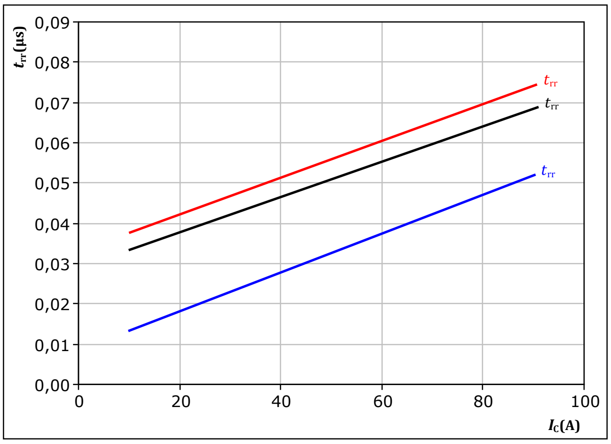
With an inductive load at

T_j =	150	°C
V_{CE} =	400	V
V_{GE} =	0/15	V
I_C =	50	A

figure 24. **FWD**

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



With an inductive load at

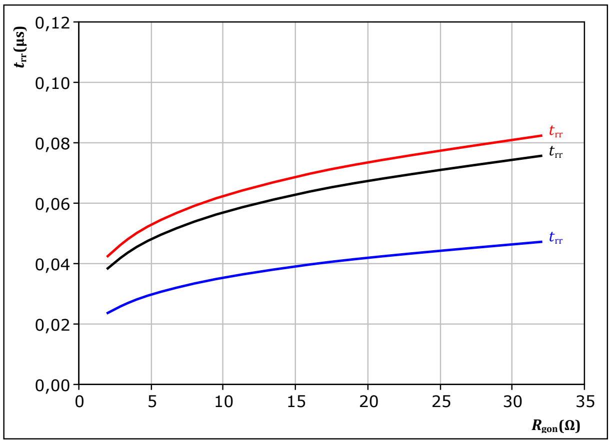
V_{CE} =	400	V
V_{GE} =	0/15	V
R_{gon} =	8	Ω

T_j: 25 °C, 125 °C, 150 °C

figure 25. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



With an inductive load at

V_{CE} =	400	V
V_{GE} =	0/15	V
I_C =	50	A

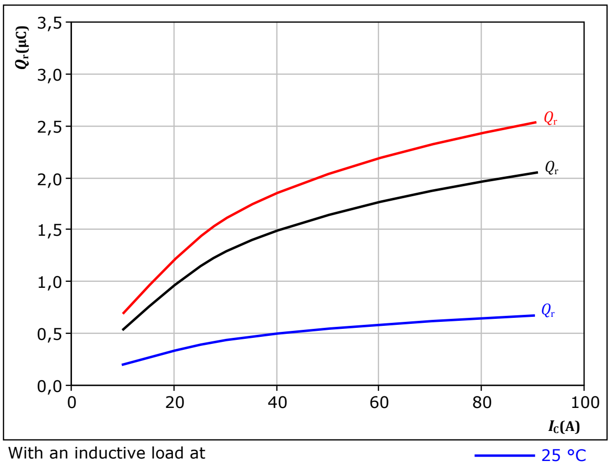
T_j: 25 °C, 125 °C, 150 °C

PFC Switching Characteristics

figure 26. **FWD**

Typical recovered charge as a function of collector current

Q_r = f(I_C)



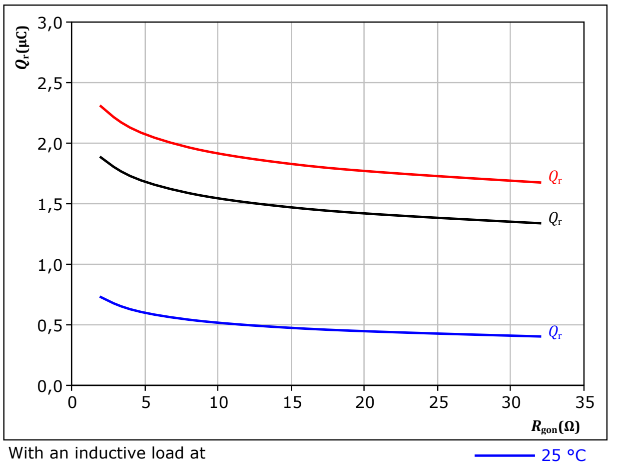
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	8	Ω		150 °C

figure 27. **FWD**

Typical recovered charge as a function of IGBT turn on gate resistor

Q_r = f(R_{gon})



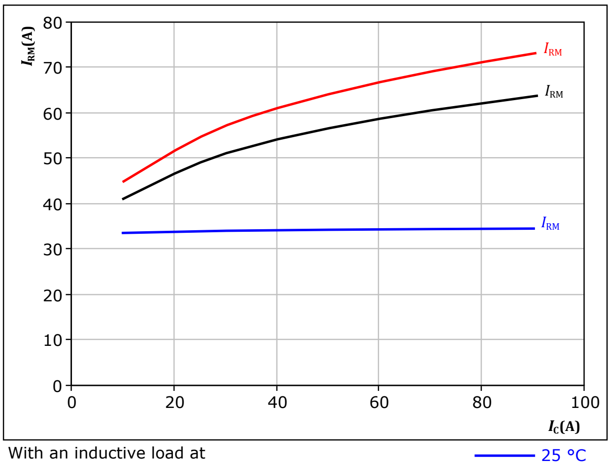
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	50	A		150 °C

figure 28. **FWD**

Typical peak reverse recovery current as a function of collector current

I_{RM} = f(I_C)



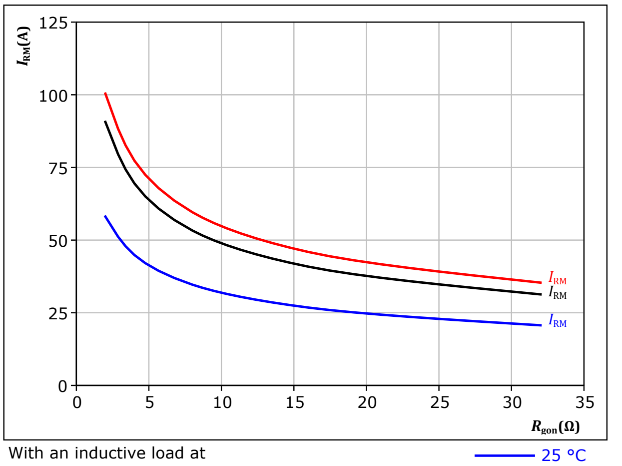
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	8	Ω		150 °C

figure 29. **FWD**

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

I_{RM} = f(R_{gon})



With an inductive load at

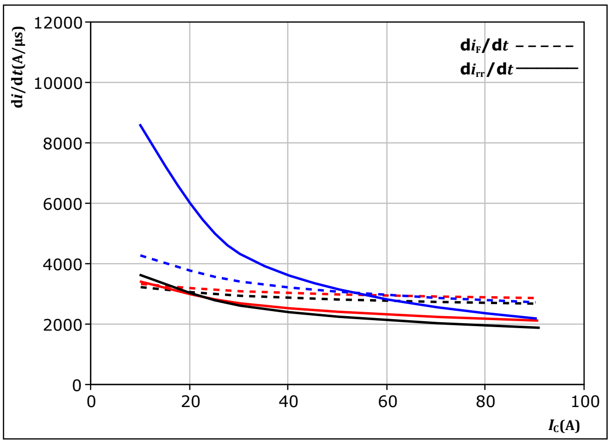
V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	50	A		150 °C

PFC Switching Characteristics

figure 30. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

di_F/dt, di_{rr}/dt = f(I_C)



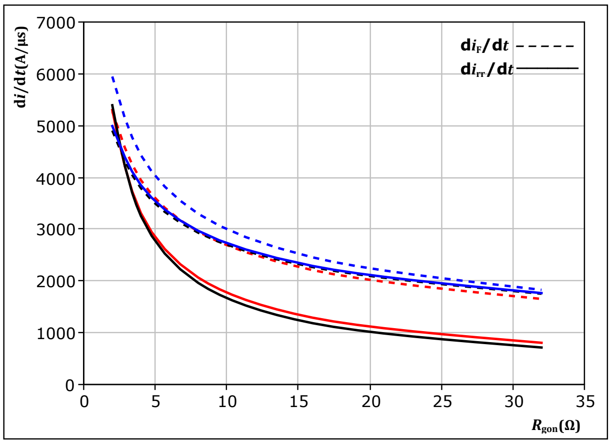
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	8	Ω		150 °C

figure 31. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

di_F/dt, di_{rr}/dt = f(R_{gon})



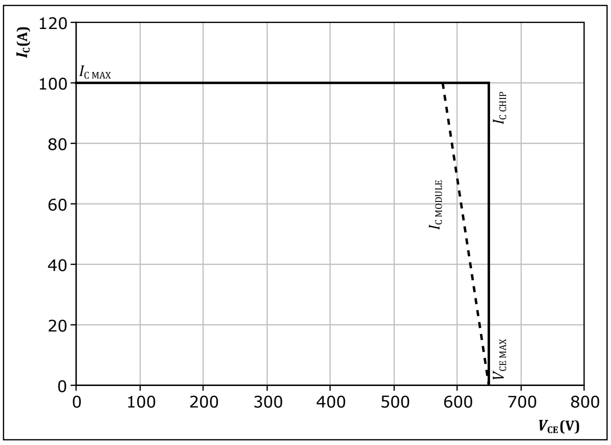
With an inductive load at

V_{CE} =	400	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	50	A		150 °C

figure 32. **IGBT**

Reverse bias safe operating area

I_C = f(V_{CE})



At	T_j =	150	°C
	R_{gon} =	8	Ω
	R_{goff} =	8	Ω

PFC Switching Definitions

figure 33. **IGBT**

Turn-off Switching Waveforms & definition of t_{doff}, t_{Eoff} (t_{tEoff} = integrating time for E_{off})

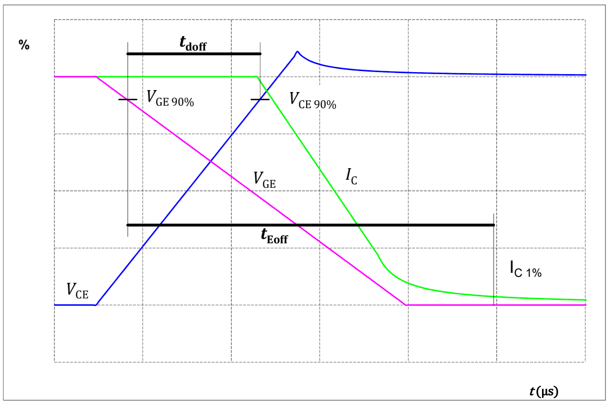


figure 34. **IGBT**

Turn-on Switching Waveforms & definition of t_{don}, t_{Eon} (t_{Eon} = integrating time for E_{on})

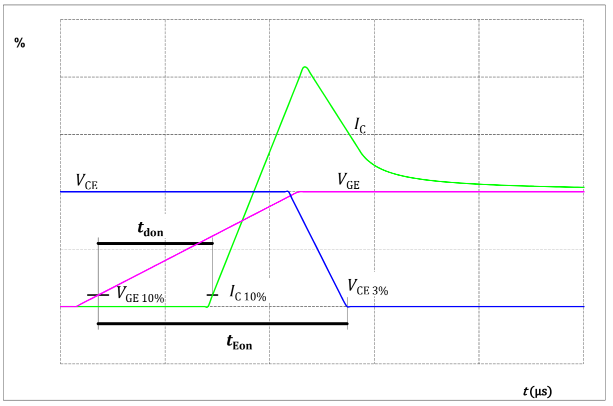


figure 35. **IGBT**

Turn-off Switching Waveforms & definition of t_f

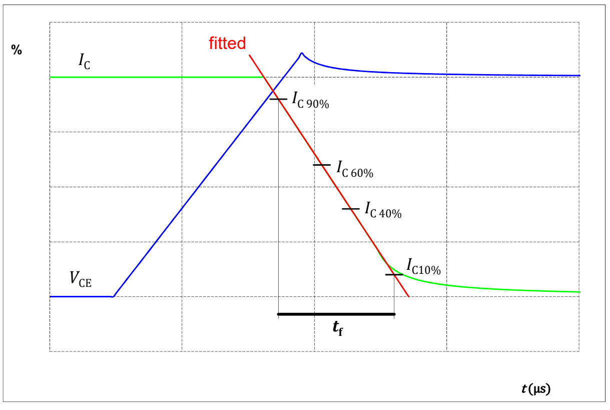
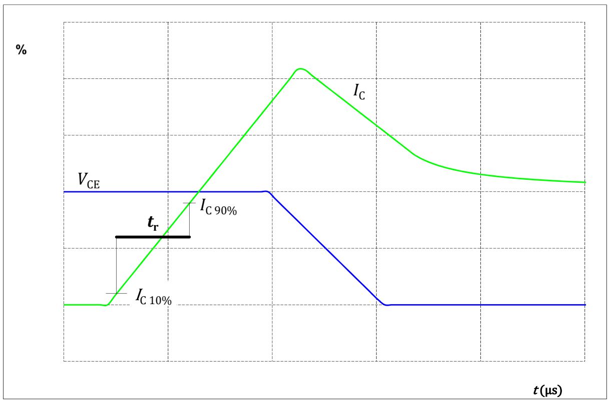


figure 36. **IGBT**

Turn-on Switching Waveforms & definition of t_r



PFC Switching Definitions

figure 37. **FWD**

Turn-off Switching Waveforms & definition of t_{rr}

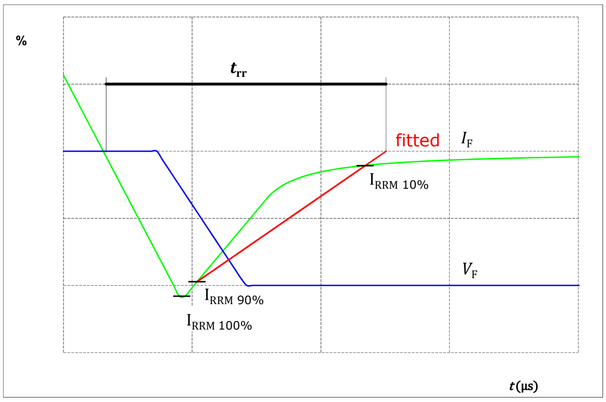
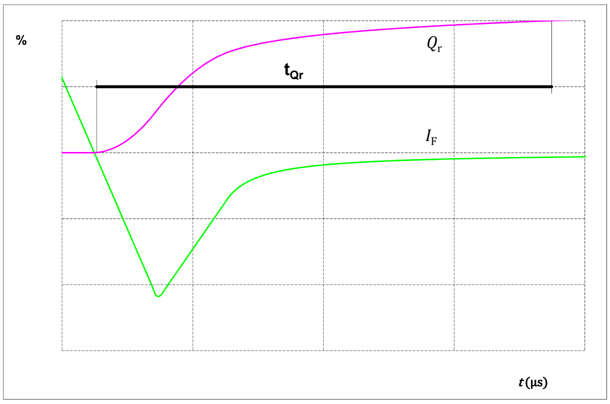


figure 38. **FWD**

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



Ordering Code

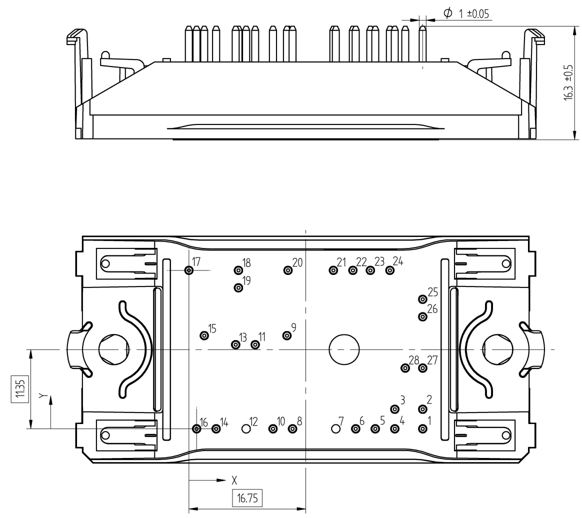
Version	Ordering Code
Without thermal paste	10-FZ062TA050SM-P987D13
With thermal paste (5,2 W/mK, PTM6000HV)	10-FZ062TA050SM-P987D13-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-FZ062TA050SM-P987D13-/3/

Marking

	**Text**	**Name**		**Date code**	**UL & VIN**	**Lot**	**Serial**
		NN-NNNNNNNNNNNNNN-TTTTTTVV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	**Type&Ver**	**Lot number**	**Serial**	**Date code**		
		TTTTTTTVV	LLLLL	SSSS	WWYY		

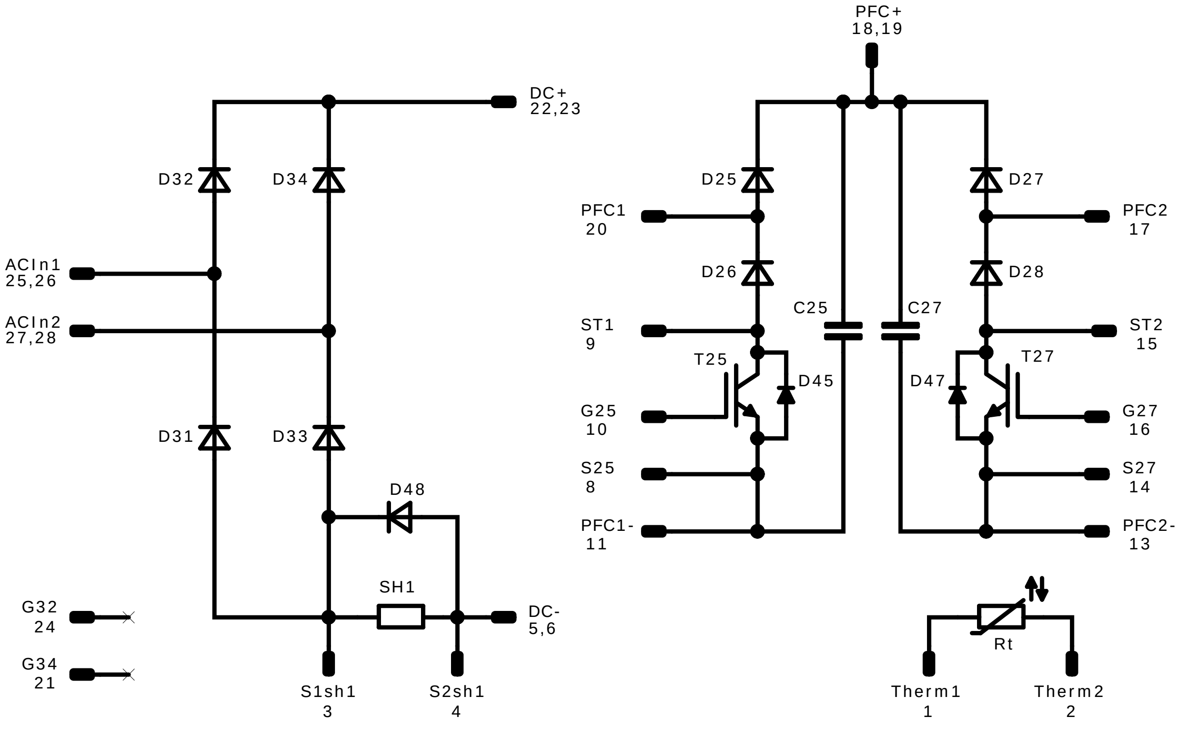
Outline

Pin table [mm]			
Pin	X	Y	Function
1	33,5	0	Therm1
2	33,5	2,8	Therm2
3	29,5	2,8	S1sh1
4	29,5	0	S2sh1
5	26,7	0	DC-
6	23,9	0	DC-
7	not assembled		
8	14,85	0	S25
9	14,05	13,35	ST1
10	12,05	0	G25
11	9,5	12,05	PFC1-
12	not assembled		
13	6,7	12,05	PFC2-
14	3,9	0	S27
15	2,2	13,35	ST2
16	1,1	0	G27
17	0	22,7	PFC2
18	7,1	22,7	PFC+
19	7,1	20,2	PFC+
20	14,2	22,7	PFC1
21	20,7	22,7	G34
22	23,5	22,7	DC+
23	26	22,7	DC+
24	28,8	22,7	G32
25	33,5	18,55	ACIn1
26	33,5	16,05	ACIn1
27	33,5	8,7	ACIn2
28	31	8,7	ACIn2



Tolerance of pinpositions: ±0,5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T25, T27	IGBT	650 V	50 A	PFC Switch	
D25, D27	FWD	600 V	30 A	PFC Diode	
D45, D47	FWD	650 V	10 A	PFC Sw. Protection Diode	
D26, D28	FWD	650 V	10 A	Current Transformer Protection Diode	
D48	Rectifier	1600 V	50 A	Shunt Protection Diode	
D31, D32, D33, D34	Rectifier	1600 V	50 A	Rectifier Diode	
SH1	Shunt			PFC Shunt	
C25, C27	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for *flow* 0 packages see vincotech.com website.

Package data
Package data for *flow* 0 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
10-FZ062TA050SM-P987D13-D2-14	11 Jul. 2022	PFC Diode change	